Designing the front-end DC/DC conversion stage to withstand automotive transients

By Vijay Choudhary

Systems and Application Engineer, Power Product Solutions

Introduction

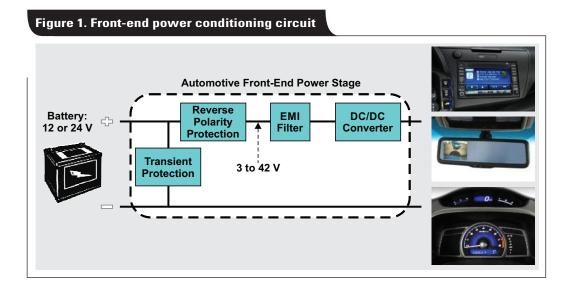
With rapidly expanding electronic content in the latest generation of cars, there is an ever increasing need for power conversion from the car's battery rail. The 12-V battery rail is subject to a variety of transients. This presents a unique challenge in terms of the power architecture for off-battery systems.

This article introduces the types of transients that occur in automotive battery rails, the causes of those transients, and the standards and specifications defining the test conditions for those transients. Different power architectures are covered for power-conversion and protection circuits to ride out the transients and minimize power interruption to the loads. Included are the advantages and trade-offs associated with buck-boost, boost, and pre-boost approaches for surviving cold-cranks and load dumps. Also presented are different approaches for reverse-polarity protection, which includes a comparison of smart diodes to alternate methods. This information can equip the designer with a deeper understanding of automotive transients and the approaches to tackle these transients when designing the power conversion stage.

Introduction to automotive transients

A variety of factors are responsible for the battery-rail transients in automotive systems . The purpose of the front-end power stage is to insulate the sensitive electrical and electronic loads from these wide variations and to power the loads with a conditioned voltage rail. Because of a large number of different vehicles, and the varied conditions of operation, it may be difficult for the designer to foresee every potential transient that will occur on the battery rail to a module. This means that a variety of testing standards must be used to determine the requirements for power conditioning.

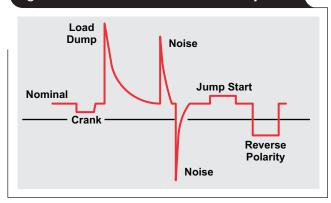
To address this concern, many original equipment manufacturers (OEMs) and organizations describe the immunity tests and the standardized test conditions for off-battery loads. A number of these tests are summarized in ISO 16750-2 and ISO 7637-2 standards.^[1, 2] However, many of the extreme transients are taken care of using the transient protection shown in Figure 1. Subsets of these stresses that are often tackled in the power-stage design,



Texas Instruments 1 AAJ 10 2017

in addition to their physical origins, are summarized in Figure 2 and Table 1. The ISO standards and a few OEM-specific documents describing these tests are referenced in Table 1.

Figure 2. Stresses on automotive battery rail



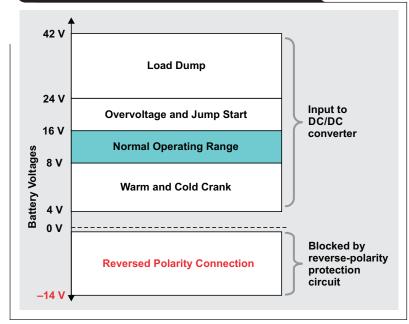
Designing the power conversion stage

The DC/DC conversion stage must be able to withstand voltages of up to ${\sim}42~\rm V$ (for $12~\rm V$ battery) during load dumps and must be able to supply power to the load during cold-crank, which can be lower than $4~\rm V$ (Figure 3). The DC/DC converter that needs to regulate the output voltage within this range must be able to step down under high-rail conditions and step up under low-rail condition. Additionally, the designer must design the reverse-polarity protection circuit to prevent or limit the damage in case of an accidental reverse-polarity connection.

Table 1. Electrical stresses and their origins^[1-3]

Test	What it Simulates	Reference Document
Load dump	Battery disconnection with alternator running with the other load remaining on the alternator rails.	ISO 16750-2 (sec 4.6.4), FMC1278 CI 222
Starting profile	Simulates the disturbances during and after cranking.	ISO 16750-2 (sec 4.6.3), FMC1278 CI 230-231
Superimposed AC	Residual voltage ripple due to rectified sinusoid from a generator.	ISO 16750-2 (sec 4.4)
	Superimposed pulses simulate sudden high-current loads switching on the battery rail.	FMC1278 CI 210, 220, GMW3172, BMW E-06
Reversed voltage	Reversed battery con- nection when using an auxiliary starting source.	ISO 16750-2 (sec 4.7)
Jump start	DC voltage overstress due to a generator failure or jump start using a 24-V battery.	ISO 16750-2 (sec 4.3), FMC1278 Cl270





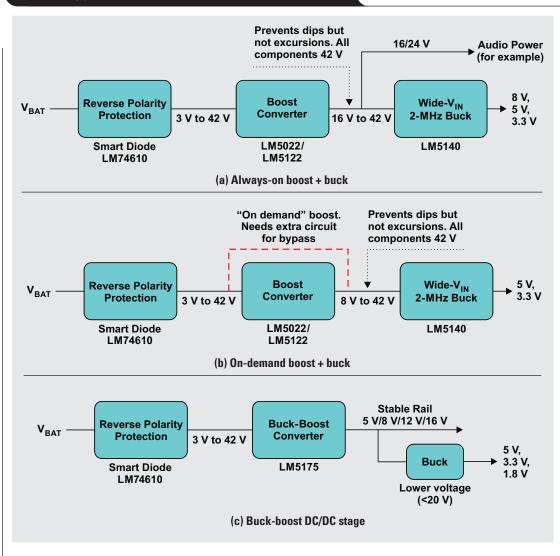
Boost + buck power stage

Figure 4 includes advantages and limitations for a few approaches to implement off-battery DC/DC conversion. One approach is to use a boost converter as the first DC/DC stage to create a higher voltage rail (Figure 4a). This is followed by a second DC/DC stage, which is a wide- $V_{\rm IN}$ buck converter. The boost action facilitates disruption-free operation when the battery-rail voltage drops too low, for example during cranking. The buck stage then steps down the voltage to the appropriate level. An important advantage of this approach is that the boost-input inductor current has relatively small ripple and it provides significant reduction in the ripple current going back to the battery rail. This reduces the attenuation required in the electromagnetic interference (EMI) filter, which means the size and cost of the EMI filter are lower.

A limitation of the boost front stage is that while it levels the dips in the battery rail voltage, it has no capability to limit the spikes, for example, during a load-dump or jump-start conditions. The following buck stage must be rated for the full load-dump voltage, which is usually around 42 V in most practical designs. This results in the size and cost of two stages that are both rated for wide-input voltage and full-load currents.

An additional cost of having two stages is the inherent double conversion in this architecture where both stages incur switching as well as conduction losses. This double conversion happens all the time, even when the battery voltage is within operating range and only step-down conversion would have been otherwise sufficient. To avoid this extra power loss due to the always-on boost stage in Figure 4a, a smarter approach is shown in Figure 4b that uses an on-demand boost stage. The on-demand boost is normally in a bypass-mode as shown by the red dashed line in Figure 4b, and only starts switching when the battery voltage falls below a pre-determined value based on the drop-out characteristic of the following buck stage. Since the boost converter is off most of the time, this

Figure 4. Approaches to off-battery DC/DC conversion



saves the switching losses in the boost stage. The boost converter must respond quickly enough to prevent the load input voltage from dropping too low. Additional circuitry may be needed to sense the battery drop and switch over from bypass to boost-on mode.

Since the on-demand boost is only expected to switch when battery voltage drops, this architecture is suitable only for relatively lower-voltage rails, such as 5 V, 3.3 V, in other words, well below the normal range of battery voltage.

Buck-boost power stage

Buck-boost converters facilitate single-stage conversion to handle the wide-range battery voltage (Figure 3) on the input and provide a regulated rail at the output. A number of different topologies are used for buck-boost conversion. ^[4] The example in Figure 4c shows the LM5175 four-switch buck-boost converter because of its higher efficiency and power-handling capabilities.

A wide- $V_{\rm IN}$ four-switch DC/DC converter can both step up and step down the input voltage and is able to regulate the output, even when the input voltage is equal to the output voltage. The simplified diagram and switching waveforms are shown in Figure 5. When the input voltage is higher than the target output, it operates in buck-mode with the output stage in the pass-through mode. When the input voltage is lower than the target output, it operates in boost mode with the input stage is in the pass-through mode. When $V_{\rm IN}$ is close to $V_{\rm OUT}$, it interleaves buck and boost cycles to maintain smooth operation. Since only one

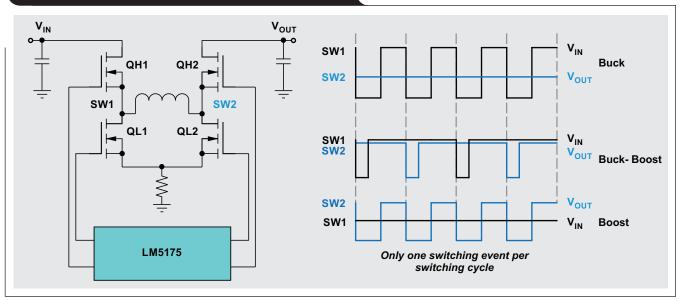
leg (buck or boost) is switching in a cycle, it avoids the higher losses associated with a two-stage conversion.

Unlike a boost pre-regulator, which only lifts the output voltage for low V_{IN} but cannot clamp the output voltage below V_{IN} , the buck-boost provides immunity against both dips and excursions in input voltage. For automotive applications with the output voltage above the nominal battery range ($\geq\!16$ V), the buck-boost converter offers low ripple at the input and provides overload and short-circuit protection, as well as inrush current limiting. A buck-boost power stage also eliminates the need for bulky low-frequency passive filters otherwise required to suppress the superimposed alternative voltage that happens on the 12-V battery rail due to rectification of alternator AC output.

For regulated outputs below the nominal battery voltage (5 V, 3.3 V), the buck-boost topology provides a single-stage solution with higher efficiency than the pre-boost + buck architecture. However, the size advantage of a single-inductor buck-boost is somewhat tempered by the fact that it typically requires a larger EMI filter.

For automotive systems, the buck-boost converter of Figure 5 is an ideal pre-regulator. This converter combines the benefits of a boost-converter front stage, such as low-input ripple (for 16- to 24-V output range, Figure 4c) and cranking protection. This converter also includes load-dump protection ($V_{\rm IN}$ excursions) and overcurrent/short-circuit protection typically associated with a buck converter. Additionally, it offers true input-output disconnection when in shutdown mode.





Reverse-polarity protection

A reverse-polarity protection circuit is needed in the front end to protect the components connected to battery rail from negative voltage, which can result from improper connection of an external power supply to start the vehicle. Many approaches are taken in automotive systems to prevent reverse-current damage, ranging from fuses, Schottky diodes, p-channel field-effect transistors (PFETs), and n-channel FETS (NFETs) as shown in Figure 6.

For lower current applications, a simple Schottky diode can be used for reverse-polarity protection. PFETs can handle higher current, but the driver circuit usually requires a pull-down resistor and a zener clamp that dissipates power. Furthermore, PFETs have inferior $R_{\rm DS(on)}$ characteristics compared to NFETs and usually are more expensive. Smart-diode controllers combine the best performance of an n-channel MOSFET with the simplicity of a diode connection.

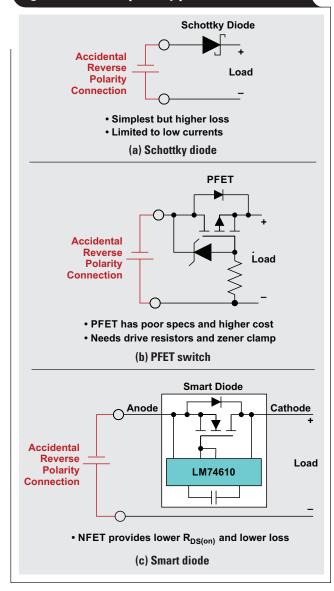
Conclusions

The front-end power-conversion stage for automotive offbattery applications must deal with a wide voltage variations on the input-voltage or battery rail. The tests to simulate these variations are covered in automotive standards and OEM-specific documents. Examples of the stress tests that are required in the power-stage design are reverse-polarity connection, cold and warm cranks during engine start/re-start, load dump, and superimposed AC within the nominal battery voltage range. The positive voltage transients and operating-voltage variations on the battery rail necessitate the use of DC/DC converters with a wide-input voltage rating to regulate or pre-regulate the bus. Depending on the load and sub-systems being powered, designers can design the power stage using a pre-boost, pre-boost and a buck, or a single-stage buckboost converter. A four-switch, buck-boost converter provides the best combination of versatility, small size, and high efficiency. There are many approaches to reversepolarity protection but smart diodes provide the best performance and a simple design.

References

- 1. ISO 16750-2: Road vehicles—Environmental conditions and testing for electrical and electronic equipment.
- 2. ISO 7637-2: Road vehicles Electrical disturbances from conduction and coupling Part 2: Electrical transient conduction along supply lines only.
- 3. FMC1278: Electromagnetic Compatibility Specification for Electrical/Electronic Components and Subsystems, Ford Motor Company (FMC1278), July 2015.
- 4. Vijay Choudhary, Timothy Hegarty and David Pace, "Under the hood of a non-inverting buck-boost converter," TI Power Supply Design Seminar 2016.

Figure 6. Reverse-polarity protection methods



- 5. Vijay Choudhary and Mathew Jacob, "Smart Diode and 4-Switch Buck-Boost Provide Ultra High Efficiency, Compact Solution for 12-V Automotive Battery Rail," PCIM Europe 2016, 10 12 May 2016, Vol. 1, pp 2019.
- Matthew Jacob, "Reverse-polarity protection comparison: diode vs. PFET vs. a smart diode solution," Texas Instruments, Behind the Wheel blog, December 21, 2015.

Related Web sites

Product information: LM5140-Q1 LM5122 LM5022 LM5175 LM74610-Q1

TI Worldwide Technical Support

TI Support

Thank you for your business. Find the answer to your support need or get in touch with our support center at

www.ti.com/support

China: http://www.ti.com.cn/guidedsupport/cn/docs/supporthome.tsp

Japan: http://www.tij.co.jp/guidedsupport/jp/docs/supporthome.tsp

Technical support forums

Search through millions of technical questions and answers at TI's E2E™ Community (engineer-to-engineer) at

e2e.ti.com

China: http://www.deyisupport.com/ Japan: http://e2e.ti.com/group/jp/

TI Training

From technology fundamentals to advanced implementation, we offer on-demand and live training to help bring your next-generation designs to life. Get started now at

training.ti.com

China: http://www.ti.com.cn/general/cn/docs/gencontent.tsp?contentId=71968

Japan: https://training.ti.com/jp

Important Notice: The products and services of Texas Instruments Incorporated and its subsidiaries described herein are sold subject to Tl's standard terms and conditions of sale. Customers are advised to obtain the most current and complete information about Tl products and services before placing orders. Tl assumes no liability for applications assistance, customer's applications or product designs, software performance, or infringement of patents. The publication of information regarding any other company's products or services does not constitute Tl's approval, warranty or endorsement thereof.

A011617

E2E is a trademark of Texas Instruments. All other trademarks are the property of their respective owners.

© 2017 Texas Instruments Incorporated.

All rights reserved.



TEXAS INSTRUMENTS

SLYT707

IMPORTANT NOTICE FOR TI DESIGN INFORMATION AND RESOURCES

Texas Instruments Incorporated ('TI") technical, application or other design advice, services or information, including, but not limited to, reference designs and materials relating to evaluation modules, (collectively, "TI Resources") are intended to assist designers who are developing applications that incorporate TI products; by downloading, accessing or using any particular TI Resource in any way, you (individually or, if you are acting on behalf of a company, your company) agree to use it solely for this purpose and subject to the terms of this Notice.

TI's provision of TI Resources does not expand or otherwise alter TI's applicable published warranties or warranty disclaimers for TI products, and no additional obligations or liabilities arise from TI providing such TI Resources. TI reserves the right to make corrections, enhancements, improvements and other changes to its TI Resources.

You understand and agree that you remain responsible for using your independent analysis, evaluation and judgment in designing your applications and that you have full and exclusive responsibility to assure the safety of your applications and compliance of your applications (and of all TI products used in or for your applications) with all applicable regulations, laws and other applicable requirements. You represent that, with respect to your applications, you have all the necessary expertise to create and implement safeguards that (1) anticipate dangerous consequences of failures, (2) monitor failures and their consequences, and (3) lessen the likelihood of failures that might cause harm and take appropriate actions. You agree that prior to using or distributing any applications that include TI products, you will thoroughly test such applications and the functionality of such TI products as used in such applications. TI has not conducted any testing other than that specifically described in the published documentation for a particular TI Resource.

You are authorized to use, copy and modify any individual TI Resource only in connection with the development of applications that include the TI product(s) identified in such TI Resource. NO OTHER LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE TO ANY OTHER TI INTELLECTUAL PROPERTY RIGHT, AND NO LICENSE TO ANY TECHNOLOGY OR INTELLECTUAL PROPERTY RIGHT OF TI OR ANY THIRD PARTY IS GRANTED HEREIN, including but not limited to any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information regarding or referencing third-party products or services does not constitute a license to use such products or services, or a warranty or endorsement thereof. Use of TI Resources may require a license from a third party under the patents or other intellectual property of TI.

TI RESOURCES ARE PROVIDED "AS IS" AND WITH ALL FAULTS. TI DISCLAIMS ALL OTHER WARRANTIES OR REPRESENTATIONS, EXPRESS OR IMPLIED, REGARDING TI RESOURCES OR USE THEREOF, INCLUDING BUT NOT LIMITED TO ACCURACY OR COMPLETENESS, TITLE, ANY EPIDEMIC FAILURE WARRANTY AND ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, AND NON-INFRINGEMENT OF ANY THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

TI SHALL NOT BE LIABLE FOR AND SHALL NOT DEFEND OR INDEMNIFY YOU AGAINST ANY CLAIM, INCLUDING BUT NOT LIMITED TO ANY INFRINGEMENT CLAIM THAT RELATES TO OR IS BASED ON ANY COMBINATION OF PRODUCTS EVEN IF DESCRIBED IN TI RESOURCES OR OTHERWISE. IN NO EVENT SHALL TI BE LIABLE FOR ANY ACTUAL, DIRECT, SPECIAL, COLLATERAL, INDIRECT, PUNITIVE, INCIDENTAL, CONSEQUENTIAL OR EXEMPLARY DAMAGES IN CONNECTION WITH OR ARISING OUT OF TI RESOURCES OR USE THEREOF, AND REGARDLESS OF WHETHER TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES.

You agree to fully indemnify TI and its representatives against any damages, costs, losses, and/or liabilities arising out of your non-compliance with the terms and provisions of this Notice.

This Notice applies to TI Resources. Additional terms apply to the use and purchase of certain types of materials, TI products and services. These include; without limitation, TI's standard terms for semiconductor products http://www.ti.com/sc/docs/stdterms.htm), evaluation modules, and samples (http://www.ti.com/sc/docs/sampterms.htm).

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2017, Texas Instruments Incorporated